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SUGAR WAFERS

CROSS REFERENCE TO RELATED APPLICATIONS

- This application is a continuation of the U.S. national phase designation of
- 5 PCT application no. PCT/EP99/04905, filed July 13, 1999, the entire content of which is expressly incorporated herein by reference thereto.

FIELD OF THE INVENTION

- The present invention relates to edible wafers, in particular sugar wafers, and
- 10 to a process for preparing them.

BACKGROUND OF THE INVENTION

- Wafers are normally made from batter recipes using from about 20% to 60% by weight of flour, water, and sucrose (which may be brown or white) together with smaller
- 15 quantities of one or more ingredients typically used in a sugar wafers, such as fat, milk, cream, milk powder, whole egg, egg powder, soya flour, salt, lecithin, colorings, cocoa powder, flavors, emulsifiers, vanilla crystals, and a raising agent. The flour is usually wheat flour but it may be another flour, such as rice flour or a flour admixed with a starch. Wafers typically have a low fat content, normally from 1 to 2% but in some cases can be up to 10%.
- 20 The main function of the fat is as an anti-sticking/releasing agent. Sugar wafers differ from standard wafers in that they contain a higher sugar content, for example, from about 40% to 70% compared with less than 5% for standard wafers.

- Wafers may be distinguished from biscuits/cookies in that wafers are the result of baking a batter whereas biscuits/cookies are baked out of dough. Batter normally
- 25 has a water content of more than 100 parts per 100 parts of flour and is a liquid suspension that will flow through a pipe. In contrast, biscuit dough is rather stiff so that it can be rolled and flattened and has a water content of less than 50 parts per 100 parts of flour.

- A major problem with standard sugar wafers is that they tend to lose their crispiness over time by absorbing moisture which softens them. Thus, the wafers lose their
- 30 characteristic and desirable textural properties. After baking the batter, there is only a limited amount of time, usually up to about 40 seconds, during which the wafers stay sufficiently flexible to allow further processing, such as modifying the shape of the wafer or filling a tubular shaped wafer.

SUMMARY OF THE INVENTION

The invention relates to a sugar wafer batter. The sugar wafer batter includes:

- 5 (i) a grain component comprising wheat flour and cereal grits in an amount sufficient to be baked into a crisp wafer; a sugar additive comprising sucrose, a reducing sugar, or a mixture thereof in an amount sufficient to provide a sweet taste to the wafer; and water in an amount sufficient to form a batter; or
- 10 (ii) a grain component comprising wheat flour in an amount sufficient to be baked into a crisp wafer; a sugar additive comprising sucrose and a reducing sugar in an amount sufficient to provide a sweet taste to the wafer; and water in an amount sufficient to form a batter.

When the grain component contains cereal grits the ratio of wheat flour to cereal grits may be from 10:90 to 80:20. The cereal grits may be corn grits, maize grits, wheat grits, oat grits, rice grits, or a combination thereof.

- 15 Water is present in the wafer batter in an amount of from 100 to 160 parts by weight per 100 parts by weight of the grain component. The sugar additive is present in an amount of from 50 to 100 parts by weight per 100 parts by weight of the grain component. When the sugar additive contains a reducing sugar, the ratio of sucrose to reducing sugar may be from 85:15 to 20:80. The reducing sugar may be fructose, glucose, glucose syrup, dextrose, corn syrup, invert sugar, a fruit juice containing a reducing sugars, honey, or a mixture thereof.

The invention also relates to a process for preparing a sugar wafer. The process involves baking the sugar wafer batter for 0.5 to 2 minutes at a temperature of from 140°C to 180°C.

- 25 The invention also relates to a sugar wafer containing fat, wheat flour, cereal grits, sucrose, and water, wherein the combination of fat, wheat flour, cereal grits, sucrose, and water account for at least 95 percent by weight of the sugar wafer; the amount of water in the sugar wafer is from about 0.5% to 6% by weight based on the weight of the sugar wafer; the sucrose is present in an amount of from 50 to 100 parts by weight per 100 parts by weight of the wheat flour and cereal grits; and the ratio of wheat flour to cereal grits to is from 10:90 to 80:20. Optionally, 15 percent to 80 percent of the sucrose may be replaced with a reducing sugar. In another embodiment the sugar wafer contains fat, wheat flour, sucrose, a reducing sugar, and water, wherein the combination of fat, wheat flour, sucrose, a reducing sugar, and water account for at least 95 percent by weight of the sugar wafer; the amount of water in the sugar wafer is from about 0.5% to 6% by weight based on the weight
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of the sugar wafer; the sucrose and reducing sugar are present in an amount of from 50 to 100 parts by weight per 100 parts by weight of the wheat flour; and the ratio of sucrose to reducing sugar is from 85:15 to 20:80.

The sugar wafer may further contain one or more of milk, cream, milk powder, whole egg, egg powder, soya flour, salt, lecithin, vanilla crystals, or a raising agent.

The invention further relates to a confectionery product containing a sugar wafer of the invention and a second confectionery material having a water activity below 0.5, wherein the second confectionery material is in direct contact with the sugar wafer. In another embodiment the confectionery product contains a sugar wafer of the invention, a second confectionery material, and a moisture barrier between the sugar wafer and the second confectionery material.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

The present invention provides a sugar wafer batter wherein part of the wheat flour is replaced by cereal grits and/or all or part of the sucrose is replaced by a reducing sugar. We have found that by replacing part of the wheat flour in a wafer batter by cereal grits and/or replacing all or part of the sucrose with a reducing sugar, it is possible to obtain a sugar wafer that is sufficiently flexible over a longer period of time compared with standard sugar wafers. Thus, the sugar wafers of the invention can be further processed while retaining their characteristic and desirable crispiness when cooled. In addition, it is possible to obtain a sugar wafer which is harder, more crunchy, and has a more coarse and gritty texture than a conventional sugar wafer.

The cereal grits may be, for example, corn grits, maize grits, wheat grits, oat grits, rice grits, and the like, or any combination of two or more thereof.

The amount of water in the sugar wafer batter of the present invention is typically from 100 to 160 parts and more preferably from 120 to 140 parts by weight per 100 parts by weight of the flour or, where part of the wheat flour is replaced by cereal grits, per 100 parts of the total weight of the wheat flour and cereal grits.

The amount of sucrose or, where all or part of the sucrose is replaced by a reducing sugar, the total amount of sucrose and reducing sugar in the sugar wafer batter of the present invention is typically from 50 to 100 parts and more preferably from 60 to 85 parts by weight per 100 parts by weight of the flour or, where part of the wheat flour is replaced by cereal grits, per 100 parts of the total weight of the wheat flour and cereal grits.

In a first embodiment of the invention, up to 90% by weight of the wheat flour in a standard sugar wafer batter is replaced by the cereal grits. Preferably from 20% to

60% and more preferably from 25% to 45% by weight of the wheat flour is replaced by the cereal grits.

Corn grits are also known as corn meal and is a ground product obtained by dry milling the endosperm of corn. The particle sizes typically vary from about 100 microns
5 to about 1mm, and preferably from 150 to 500 microns.

In a second embodiment of the invention, all or part of the sucrose in a standard sugar wafer batter is replaced by a reducing sugar. For example, from 15 to 80% by weight of the sucrose may be replaced by the reducing sugar. Preferably from 20% to 50% and more preferably from 25% to 40% by weight of the sucrose is replaced by the
10 reducing sugar. The reducing sugar may be, for example, fructose; glucose; glucose syrup; dextrose; corn syrup; invert sugar; fruit juices containing reducing sugars, such as grape juice; or honey.

Advantageously, both part of the flour in a standard sugar wafer batter is replaced by cereal grits and part of the sucrose in a standard sugar wafer batter is replaced
15 by a reducing sugar.

The sugar wafers may be prepared by baking the sugar wafer batter of the invention. The sugar wafer batter may be baked by any conventional method well known to those skilled in the art to make a sugar wafer. For example the sugar wafer batter may be baked using a baking oven, a baking machine, a molding cone, baking plates, or on the
20 surface of a sugar wafer drum. The baking temperature may be from 140°C to 180°C, preferably from 150°C to 170°C, and more usually from 160°C to 165°C. The baking may be carried out over a period of from 0.5 to 2 minutes and preferably from 0.75 to 1.5 minutes.

Accordingly, the present invention also provides a sugar wafer in which part
25 of the flour is replaced by cereal grits and/or all or part of the sucrose is replaced by a reducing sugar.

The amount of water in the sugar wafer according to the present invention is typically from about 0.5% to 6% and preferably from 0.75 to 3% by weight based on the total weight of the sugar wafer. The remaining ingredients of the sugar wafer according to
30 the present invention, based on the weight of the wheat flour or, where part of the wheat flour is replaced by cereal grits, per 100 parts of the total weight of the wheat flour and cereal grits, remain substantially the same.

The total amount of water, fat, wheat flour, and sucrose together with their replacements in the sugar wafer usually accounts for at least 95%, for example, from 96% to
35 98% by weight of the sugar wafer. The remaining ingredients include one or more

ingredients typically used in a sugar wafers, such as milk; cream; milk powder; whole egg; egg powder; soya flour; salt; lecithin; colorings, such as caramel color; cocoa powder; flavors; emulsifiers; vanilla crystals; and a raising agent.

5 The sugar wafers of the present invention may have a variety of shapes and sizes, for example, they may be flat sheets, cup or cone-shaped, or they may be tubular. If desired, the sugar wafers may be further processed after baking, for example, they may be crimped, pressed, or shaped in a mold. The sugar wafers of the present invention may be used in a variety of confectionery products together with confectionery materials such as ice
10 creams, chocolates, or other fatty materials such as fat-based creams. The tubular wafers may be filled with confectionery materials, preferably of low water activity so that a minimum of moisture migration occurs. For example the confectionery material may be a savory filling, ice cream, or fat-based creams containing yoghurt. The sugar wafers of the present invention are sufficiently flexible under ambient conditions after baking for more than 40 seconds, preferably more than 50 seconds, and more preferably up to 70 seconds or
15 more to enable further processing.

The present invention further provides a confectionery product comprising a sugar wafer according to the present invention together with a confectionery material. The sugar wafer may be in direct contact with the confectionery material or, if desired, a moisture barrier may be used between the surface of the sugar wafer and the confectionery
20 material. For example, the moisture barrier may conveniently be coated on the surface of the sugar wafer adjacent to the confectionery material. Any conventional food-acceptable moisture barrier may be used. Preferably a fat-based moisture barrier such as chocolate or chocolate substitute is used as the moisture barrier. When the confectionery product comprising the sugar wafer is used in direct contact with a confectionery material, the
25 confectionery material preferably has a low water activity, for example, a water activity below 0.5 and preferably below 0.3.

The confectionery product comprising the sugar wafer may, if desired, be enrobed with another suitable confectionery material, for example, with plain, white, or milk chocolate or with a chocolate substitute.

30 The confectionery product comprising the sugar wafer may be refrigerated or frozen.

EXAMPLES

The invention is further defined by reference to the following examples
35 describing in detail the preparation of the sugar wafers of the present invention. The

invention described and claimed herein is not to be limited in scope by the specific embodiments herein disclosed, since these embodiments are intended as illustrations of several aspects of the invention. Any equivalent embodiments are intended to be within the scope of this invention. Indeed, various modifications of the invention in addition to those shown and described herein will become apparent to those skilled in the art from the foregoing description. Such modifications are also intended to fall within the scope of the appended claims.

Example 1:

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A sugar wafer batter is prepared having the following ingredients:

	Water	41.8%
	Wheat flour	19.4%
15	Corn grits	12.9%
	Brown sugar	15.3%
	Honey	7.9%
	*Other ingredients	2.7%

* Other ingredients includes milk powder, egg powder, soya flour, salt, lecithin, and vanilla crystals.

The above batter is fed as a suspension onto the surface of a drum of a wafer baking machine and baked at 162°C for 1 minute to form a wafer sheet having a water content below 5% by weight. The wafer sheet is then passed to a spindle and rolled to form a tube. The tube is filled with a fat-based cream containing yoghurt, closed at each end, and shaped mechanically as desired. The wafer is sufficiently flexible for a period of 60 seconds after baking which allows this further processing. The tube is finally enrobed with a layer of plain chocolate. The resulting product is then refrigerated.

On eating the resulting product, a panel of seven expert tasters found that the wafer was harder, more crunchy, and had a more coarse and gritty texture than a conventional sugar wafer. These findings were supported by mechanical and sensory analysis.

Immediately after baking, the sugar wafer was found to remain flexible for over 100 seconds which is significantly longer than a standard wafer. Moreover, the cooling rate was reduced compared to a standard wafer, and the temperature at

which the wafer became brittle was also reduced to 77°C compared with 93°C for a standard wafer.

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THE CLAIMS

What is claimed is:

5 1. A sugar wafer batter comprising:

(i) a grain component comprising wheat flour and cereal grits in an amount sufficient to be baked into a crisp wafer; a sugar additive comprising sucrose, a reducing sugar, or a mixture thereof in an amount sufficient to provide a sweet taste to the wafer; and water in an amount sufficient to form a batter; or

10 (ii) a grain component comprising wheat flour in an amount sufficient to be baked into a crisp wafer; a sugar additive comprising sucrose and a reducing sugar in an amount sufficient to provide a sweet taste to the wafer; and water in an amount sufficient to form a batter.

15 2. The sugar wafer batter of claim 1, wherein the grain component contains cereal grits and the ratio of wheat flour to cereal grits is from 10:90 to 80:20.

3. The sugar wafer batter of claim 2, wherein cereal grits are corn grits, maize grits, wheat grits, oat grits, rice grits, or a combination thereof.

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4. The sugar wafer batter of claim 1, wherein the water is present in an amount of from 100 to 160 parts by weight per 100 parts by weight of the grain component.

5. The sugar wafer batter of claim 1, wherein the sugar additive is present in an amount
25 of from 50 to 100 parts by weight per 100 parts by weight of the grain component.

6. The sugar wafer batter of claim 1, wherein the sugar additive contains a reducing sugar and the reducing sugar is fructose, glucose, glucose syrup, dextrose, corn syrup, invert sugar, a fruit juice containing a reducing sugars, honey, or a mixture thereof.

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7. The sugar wafer batter of claim 1, wherein the sugar additive contains a reducing sugar and the ratio of sucrose to reducing sugar is from 85:15 to 20:80.

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8. A process for preparing a sugar wafer comprising baking the sugar wafer batter of claim 1 for 0.5 to 2 minutes at a temperature of from 140°C to 180°C to form a sugar wafer.
- 5 9. A sugar wafer comprising fat, wheat flour, cereal grits, sucrose, and water, wherein the combination of fat, wheat flour, cereal grits, sucrose, and water account for at least 95 percent by weight of the sugar wafer; the amount of water in the sugar wafer is from about 0.5% to 6% by weight based on the weight of the sugar wafer; the sucrose is present in an amount of from 50 to 100 parts by weight per 100 parts by weight of the wheat flour and
10 cereal grits; and the ratio of wheat flour to cereal grits to is from 10:90 to 80:20.
10. The sugar wafer according of claim 9, further comprising one or more of milk, cream, milk powder, whole egg, egg powder, soya flour, salt, lecithin, vanilla crystals, or a raising agent.
- 15 11. The sugar wafer of claim 10, wherein 15 percent to 80 percent of the sucrose is replaced with a reducing sugar.
12. The sugar wafer according of claim 11, further comprising one or more of milk,
20 cream, milk powder, whole egg, egg powder, soya flour, salt, lecithin, vanilla crystals, or a raising agent.
13. A sugar wafer comprising fat, wheat flour, sucrose, a reducing sugar, and water, wherein the combination of fat, wheat flour, sucrose, a reducing sugar, and water account
25 for at least 95 percent by weight of the sugar wafer; the amount of water in the sugar wafer is from about 0.5% to 6% by weight based on the weight of the sugar wafer; the sucrose and reducing sugar are present in an amount of from 50 to 100 parts by weight per 100 parts by weight of the wheat flour; and the ratio of sucrose to reducing sugar is from 85:15 to 20:80.
- 30 14. The sugar wafer according of claim 13, further comprising one or more of milk, cream, milk powder, whole egg, egg powder, soya flour, salt, lecithin, vanilla crystals, or a raising agent.

15. A confectionery product comprising the sugar wafer of claim 9 and a second confectionery material having a water activity below 0.5, wherein the second confectionery material is in direct contact with the sugar wafer.

5 16. A confectionery product comprising the sugar wafer of claim 11 and a second confectionery material having a water activity below 0.5, wherein the second confectionery material is in direct contact with the sugar wafer.

17. A confectionery product comprising the sugar wafer of claim 13 and a second
10 confectionery material having a water activity below 0.5, wherein the second confectionery material is in direct contact with the sugar wafer.

18. A confectionery product comprising the sugar wafer of claim 9, a second confectionery material, and a moisture barrier between the sugar wafer and the second
15 confectionery material.

19. A confectionery product comprising the sugar wafer of claim 11, a second confectionery material, and a moisture barrier between the sugar wafer and the second confectionery material.

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20. A confectionery product comprising the sugar wafer of claim 13, a second confectionery material, and a moisture barrier between the sugar wafer and the second confectionery material.

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SUGAR WAFERS

ABSTRACT

5 A sugar wafer batter containing wheat flour, cereal grits, sucrose, and water,
optionally with some or all of the sucrose replaced with a reducing sugar; or wheat flour,
sucrose, a reducing sugar, and water. The sugar wafer batter is baked to make sugar wafers
that are harder, more crunchy, and having a more coarse and gritty texture than a
conventional sugar wafer. After the sugar wafer batter is baked, the resulting sugar wafers
10 can be further processed for an extended period of time but still retain their characteristic
and desirable crispiness when cooled. The sugar wafers can be used in a variety of
confectionery products.

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